

#### **Features**

- High Density Cell Design for Extremely Low R<sub>DS(ON)</sub>
- · Rugged and Reliable
- Epoxy Meets UL 94 V-0 Flammability Rating
- · Moisture Sensitivity Level 1
- · Halogen Free Available Upon Request By Adding Suffix "-HF"
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

# **Maximum Ratings**

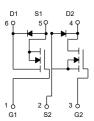
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Maximum Thermal Resistance: 100°C/W Junction to Ambient<sup>(Note1)</sup>

| Parameter                               | Symbol          | Rating | Unit |
|---|-----------------|--------|------|
| Drain-Source Voltage                    | V <sub>DS</sub> | 20     | V    |
| Gate-Source Volltage                    | V <sub>GS</sub> | ±8     | V    |
| Continuous Drain Current                | I <sub>D</sub>  | 3      | Α    |
| Pulsed Drain Current <sup>(Note2)</sup> | I <sub>DM</sub> | 10     | Α    |
| Total Power Dissipation                 | P <sub>D</sub>  | 1.25   | W    |

Note 1. Surface Mounted on FR4 Board, t < 10 sec.

2. Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature.

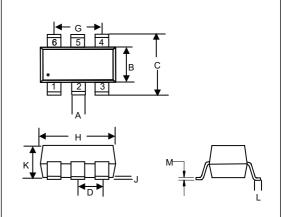
## **Internal Structure**



Marking:2322A

# Dual N-Channel Mosfet





| DIMENSIONS |        |       |      |      |      |
|------------|--------|-------|------|------|------|
| DIM        | INCHES |       | MM   |      | NOTE |
| DIIVI      | MIN    | MAX   | MIN  | MAX  | NOTE |
| Α          | 0.012  | 0.020 | 0.30 | 0.50 |      |
| В          | 0.051  | 0.070 | 1.30 | 1.80 |      |
| С          | 0.087  | 0.126 | 2.20 | 3.20 |      |
| D          | 0.037  |       | 0.95 |      | TYP. |
| G          | 0.074  |       | 1.90 |      | TYP. |
| Н          | 0.106  | 0.122 | 2.70 | 3.10 |      |
| J          | 0.002  | 0.006 | 0.05 | 0.15 |      |
| K          | 0.030  | 0.051 | 0.75 | 1.30 |      |
| L          | 0.012  | 0.024 | 0.30 | 0.60 |      |
| M          | 0.003  | 0.008 | 0.08 | 0.22 |      |



# Electrical Characteristics @ 25°C (Unless Otherwise Specified)

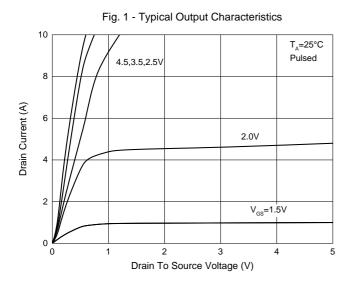
| Parameter                                 | Symbol               | Test conditions  | Min  | Тур   | Max  | Unit |
|---|----------------------|--|------|-------|------|------|
| Off Characteristics                       |                      |  |      |       | 1    |      |
| Drain-Source Breakdown Voltage            | V <sub>(BR)DSS</sub> | V <sub>GS</sub> =0V, I <sub>D</sub> =10μA                        | 20   |       |      | V    |
| Zero Gate Voltage Drain Current           | I <sub>DSS</sub>     | V <sub>DS</sub> =20V, V <sub>GS</sub> =0V                        |      |       | 1    | μA   |
| Gate-Source Leakage Current               | I <sub>GSS</sub>     | $V_{DS} = 0V$ , $V_{GS} = \pm 8V$                                |      |       | ±100 | nA   |
| On Characteristics <sup>(Note 3)</sup>    |                      |  |      |       |      |      |
| Gate-Threshold Voltage                    | V <sub>GS(th)</sub>  | $V_{DS}=V_{GS}$ , $I_{D}=50\mu A$                                | 0.55 |       | 1.25 | V    |
| Drain-Source On-Resistance                |                      | V <sub>GS</sub> =4.5V, I <sub>D</sub> =3.6A                      |      | 20    | 30   |      |
|   | R <sub>DS(on)</sub>  | V <sub>GS</sub> =2.5V, I <sub>D</sub> =3.1A                      |      | 30 40 |      | mΩ   |
| Forward Tranconductance                   | g <sub>FS</sub>      | V <sub>DS</sub> =5V, I <sub>D</sub> =3.6A                        |      | 8.5   |      | S    |
| Dynamic Characteristics(Note 4            | )                    |  |      |       |      |      |
| Input Capacitance                         | C <sub>iss</sub>     |  |      | 500   |      |      |
| Output Capacitance                        | C <sub>oss</sub>     | $V_{DS}$ =10V, $V_{GS}$ =0V,f =1MHz                              |      | 100   |      | pF   |
| Reverse Transfer Capacitance              | C <sub>rss</sub>     |  |      | 60    |      |      |
| Switching Characteristics (Note           | 4)                   |  |      |       |      |      |
| Turn-On Delay Time                        | t <sub>d(on)</sub>   |  |      | 23    | 45   |      |
| Turn-On Rise Time                         | t <sub>r</sub>       | V <sub>GS</sub> =4.5V,V <sub>DD</sub> =10V,I <sub>D</sub> =3.6A, |      | 11    | 30   |      |
| Turn-Off Delay Time                       | t <sub>d(off)</sub>  | R <sub>GEN</sub> =6Ω   |      | 34    | 70   | - ns |
| Turn-Off Fall Time                        | t <sub>f</sub>       |  |      | 36    | 70   |      |
| Total Gate Charge                         | $Q_g$                |  |      | 6     | 10   |      |
| Gate-Source Charge                        | Q <sub>gs</sub>      | $V_{DS}$ =10V, $I_{D}$ =3.6A, $V_{GS}$ =4.5V                     |      | 1.4   |      | nC   |
| Gate-Drain Charge                         | $Q_{gd}$             |  |      | 1.8   |      |      |
| Drain-Source Diode Characte               | ristics and          | d Maximum Ratings  |      |       |      |      |
| Drain-Source Diode Forward<br>Current     | Is                   |  |      |       | 3    | А    |
| Diode Forward Voltage <sup>(Note 3)</sup> | $V_{SD}$             | V <sub>GS</sub> =0V, I <sub>S</sub> =3A                          |      |       | 1.2  | V    |

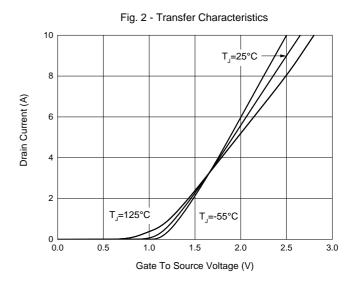
Note: 3. Pulse Test : Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2%.

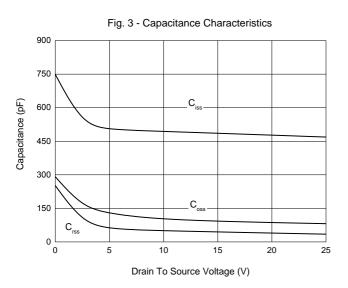
4. Guaranteed by Design, Not Subject to Production Testing.

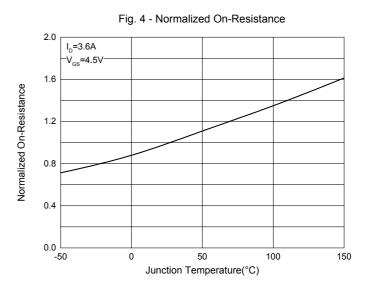


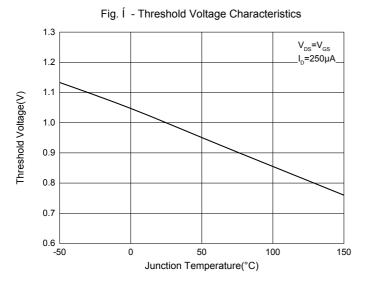
## **Curve Characteristics**

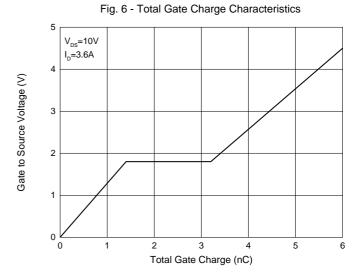














## **Ordering Information**

| Device         | Packing               |
|----------------|-----------------------|
| Part Number-TP | Tape&Reel: 3Kpcs/Reel |

Note: Adding "-HF" Suffix for Halogen Free, eg. Part Number-TP-HF

#### \*\*\*IMPORTANT NOTICE\*\*\*

**Micro Commercial Components Corp**. reserves the right to make changes without further notice to any product herein to make corrections, modifications, enhancements, improvements, or other changes. **Micro Commercial Components Corp**. does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold **Micro Commercial Components Corp**, and all the companies whose products are represented on our website, harmless against all damages.

#### \*\*\*LIFE SUPPORT\*\*\*

MCC's products are not authorized for use as critical components in life support devices or systems without the express written approval of Micro Commercial Components Corporation.

### \*\*\*CUSTOMER AWARENESS\*\*\*

Counterfeiting of semiconductor parts is a growing problem in the industry. Micro Commercial Components (MCC) is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. MCC strongly encourages customers to purchase MCC parts either directly from MCC or from Authorized MCC Distributors who are listed by country on our web page cited below. Products customers buy either from MCC directly or from Authorized MCC Distributors are genuine parts, have full traceability, meet MCC's quality standards for handling and storage. MCC will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. MCC is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.